Electronic Patent Application Fee Transmittal								
Application Number:	10519152							
Filing Date:	10-Aug-2005							
Title of Invention:	POROUS SUBSTRATE AND FABRICATION METHOD THEREFOR, AND GAN SERIES SEMICONDUCTOR LAYERED SUBSTRATE AND FABRICATION METHOD THEREFOR							
First Named Inventor/Applicant Name:	Masatomo Shibata							
Filer:	Paul J. Esatto/Vivian Connor							
Attorney Docket Number:	23165							
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Patent-Appeals-and-Interference:								
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